

# **APPROVAL SHEET**

MODEL NO: COG-T500MTWH-01P							
pproval option:   Specification							
	ample						
■ Customer's Confirmation							
Customer:							
Approved by:							
Date:							
Note:							
■ Center Confirmed:	■ Center Confirmed:						
Approved	Checked by	Made by					



# **Records of Revision**

DATE	REF.PAGE PARAGRAPH DRAWING No.	REVISED No.	SUMMARY	REMARK
2012-9-13		01	First issue	
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## 1. Introduction

## 1.1 Scope of application

This specification applies to the Negative type TFT transmissive dot matrix LCD module ,This LCD module should be designed for mobile phone use.

LCD specification: Dots 800xRGBx480.

As to basic specification of the driver IC, refer to the IC (HX8664B+HX8264D) specification and datasheet.

#### 1.2 Structure:

Double display structure: TFT Module + FPC +BL+TP FULL 16.7M Color 5.0inch TFT LCD size for main LCD; One bare chip with gold bump (COG) TECH; 24BIT RGB interface;

### 1.3 TFT features:

Structure: TFT PANNEL+IC+FPC+BL;
Transmissive Type LCD
800 dot-source and 480 dot-gate outputs;
White LED back light;
24BIT RGB interface;

## 1.4 Applications:

Mobile phone

**PSP** 

**PDA** 

**GPS** 

Etc...

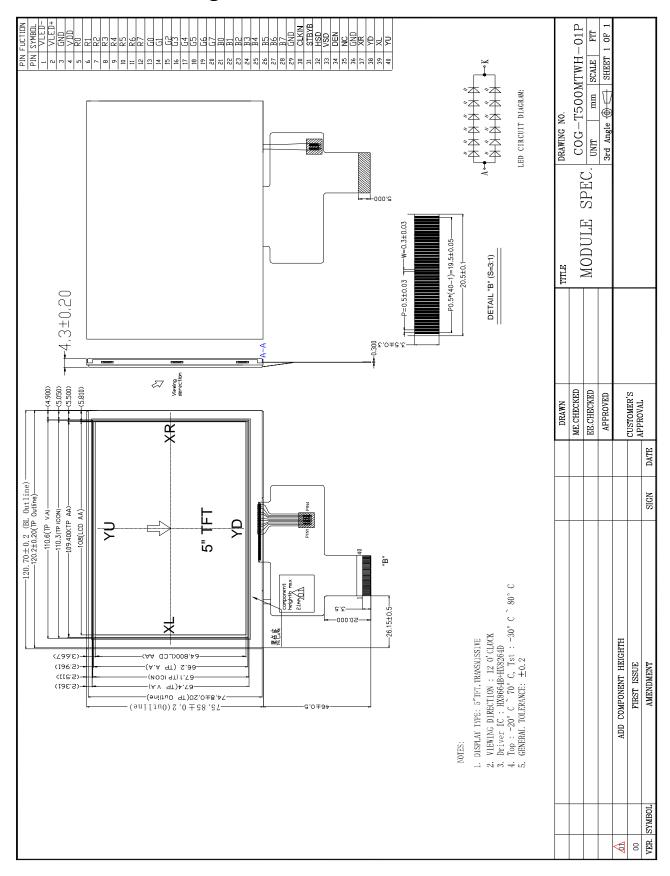


# 2. General specification

ITEM	Standard value	UNIT
LCD Type	TFT Transmissive	
Driver element	a-Si TFT Active matrix	
Number of Dots	800*(RGB)*480	Dots
Pixel Arrangement	RGB Vertical Stripe	
Active Area	108 *64.8	mm
Viewing Area (W*H)	/	mm
Viewing Direction	12 O'clock	
Driver IC	HX8664B+HX8264D	
Module Size(W*H*T)	120.76x75.85x4.3	mm
Approx. Weight	90	g
Back Light	White LED	•
System interface	24 Bit RGB interface	
Backlight power consumption	730mW	
Panel power consumption	~350mW	



# 3. Mechanical drawing





## 4. ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Min	Max	Unit
Supply voltage for logic	$V_{dd}$	-0.3	4.0	V
Input voltage for logic	V <sub>IN</sub>	-0.5	V <sub>dd</sub> +0.3	V
Supply current (One LED)	I <sub>LED</sub>		60	mA
Operating temperature	T <sub>OP</sub>	-20	+70	°C
Storage temperature	T <sub>ST</sub>	-30	+80	°C

## 5. ELECTRICAL CHARACTERISTICS

# 5.1 Typical Operation Conditions

Item	Symbol	Min	Тур	Max	Unit	Applicable terminal
Supply voltage	$V_{dd}$	3.0	3.3	3.6	V	$V_{ m DD}$
Innut valtage	$V_{\rm IL}$	-0.3	-	0.2 V <sub>dd</sub>	V	
Input voltage	$V_{\mathrm{IH}}$	0.8 V <sub>dd</sub>	-	V <sub>dd</sub>	V	
Input leakage current	$I_{LKG}$	-	-	-	μΑ	

## 5.2 Backlight Driving Conditions

Itama	Cymab al		Values	Unit	Dl-	
Item	Symbol	Min.	Тур.	Max.	Omi	Remark
Voltage for LED backlight	$V_{\rm L}$	(17.4)	(18.3)	(19.6)	V	Note 1
Current for LED backlight	$I_{L}$	(30)	(40)	(50)	mA	
LED life time	-	20,000	-	1	Hr	Note 2

Note 1: The LED Supply Voltage is defined by the number of LED at Ta=25°C and  $I_L$  =40mA.

Note 2: The "LED life time" is defined as the module brightness decrease to 50% original brightness at Ta=25°C and  $I_L$  =40mA. The LED lifetime could be decreased if operating  $I_L$  is lager than 50mA.



# 5.3. Timing Characteristics

## 5.3.1. AC Electrical Characteristics

	G 1 1		Values		TT '.	D 1
Item	Symbol	Min.	Тур.	Max.	Unit	Remark
HS setup time	Thst	8	-	-	ns	
HS hold time	Thhd	8	-	-	ns	
VS setup time	Tvst	8	-	-	ns	
VS hold time	Tvhd	8	-	-	ns	
Data setup time	Tdsu	8	-	-	ns	
Data hold time	Tdhd	8	-	-	ns	
DE setup time	Tesu	8	-	-	ns	
DE hold time	Tehd	8	-	-	ns	
DV <sub>DD</sub> Power On Slew rate	Tpor	-	-	20	ms	From 0 to 90% $DV_{DD}$
RESET pulse width	Trst	10	-	-	ms	
DCLK cycle time	Tcoh	20	-	-	ns	
DCLK pulse duty	Tewh	40	50	60	%	



### 5.3.2. Data Input Format

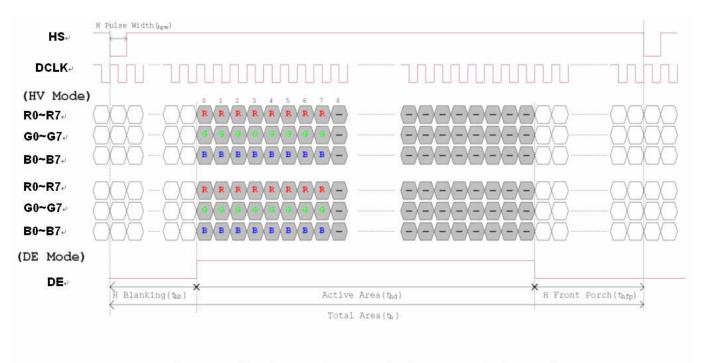


Figure 3. 1 Horizontal input timing diagram.

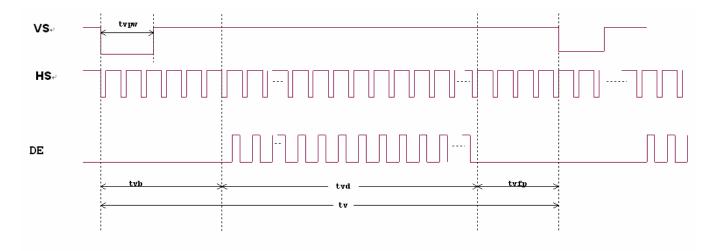


Figure 3. 2 Vertical input timing diagram.



## 5.3.3. Timing

14	Symple of		Values	Unit	Remark	
Item	Symbol	Min.	Тур.	Max.	Unit	Remark
Horizontal Display Area	thd	-	800	-	DCLK	
DCLK Frequency	fclk		30	50	MHz	
One Horizontal Line	th	889	928	1143	DCLK	
HS pulse width	thpw	1	48-	255	DCLK	
HS Blanking	thb		88		DCLK	
HS Front Porch	thfp	1	40	255	DCLK	

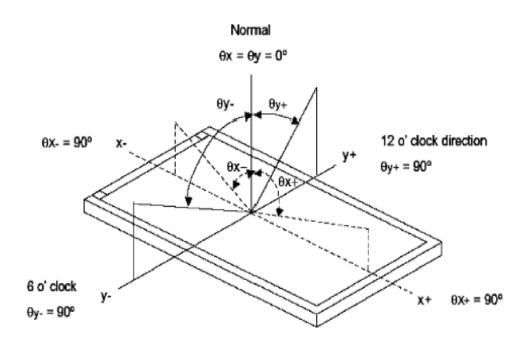
	Cymhal		Values	Unit	Dl-	
Item	Symbol	Min.	Тур.	Max.	Ullit	Remark
Vertical Display Area	tvd	-	480	-	TH	
VS period time	tv	513	525	767	TH	
VS pulse width	tvpw	3	3	255	TH	
VS Blanking	tvb		32		TH	
VS Front Porch	tvfp	1	13	255	TH	



## **6. OPTICAL CHARACTERISTICS**

ITEN	Λ	SYMBOL	CONDITIONS	SPEC	SPECIFICATIONS		LINIT	NOTE
IIEN	ITEM SYI		CONDITIONS	MIN.	TYP.	MAX	UNIT	NOTE
Brightness		В		180	220		Cd/m <sup>2</sup>	
Contrast Ratio	)	CR		=	500			
Response Tim	ne	Tr+Tf			20		ms	
	Red	XR		0.540	0.590	0.640		
		YR	Viewing	0.300	0.350	0.400		
CIE	Green	<b>X</b> G	normal angle	0.298	0.348	0.398		All left side
Color		Y <sub>G</sub>		0.520	0.570	0.620		data are based
coordinate	Blue	Хв		0.095	0.145	0.195		on TIANMA's
Coordinate		YB		0.060	0.110	0.160		product
	White	Xw		0.260	0.310	0.360		reference only
		Yw		0.280	0.330	0.380		reference offing
	Hor.	$\theta_{\scriptscriptstyle X+}$		60	70			
Viewing		$ heta_{\scriptscriptstyle X-}$	Center	60	70		Dog	
Angle	Ver.	$\theta_{\scriptscriptstyle Y+}$	CR>=10	40	50		Deg.	
		$ heta_{\scriptscriptstyle Y-}$		60	70			
Uniformity	Un			75	80		%	

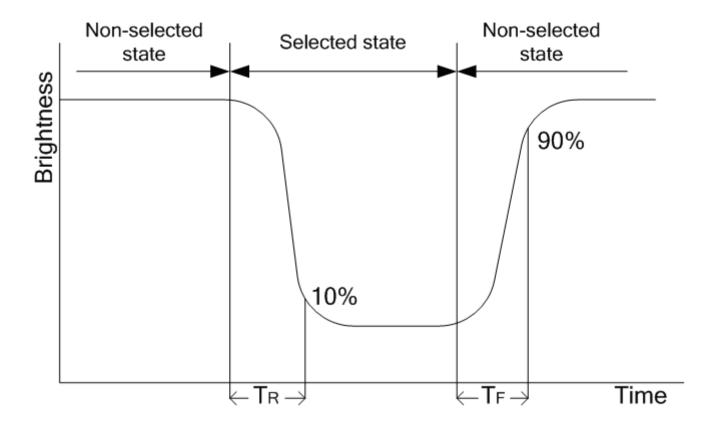
Note 1 : Definition of Viewing Angle  $\theta$  x and  $\theta$  y:





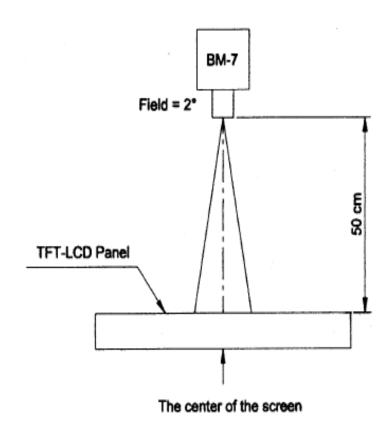
## Note 2: Definition of contrast ratio CR:

## Note 3: Definition of response time (TR, TF)

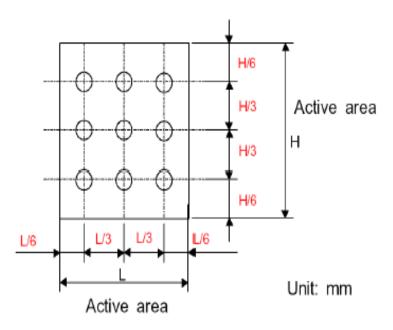




## : The brightness test equipment setup 20mA Field=2° (As measuring "black" image, field=2° is the best testing condition)



## Note 4:





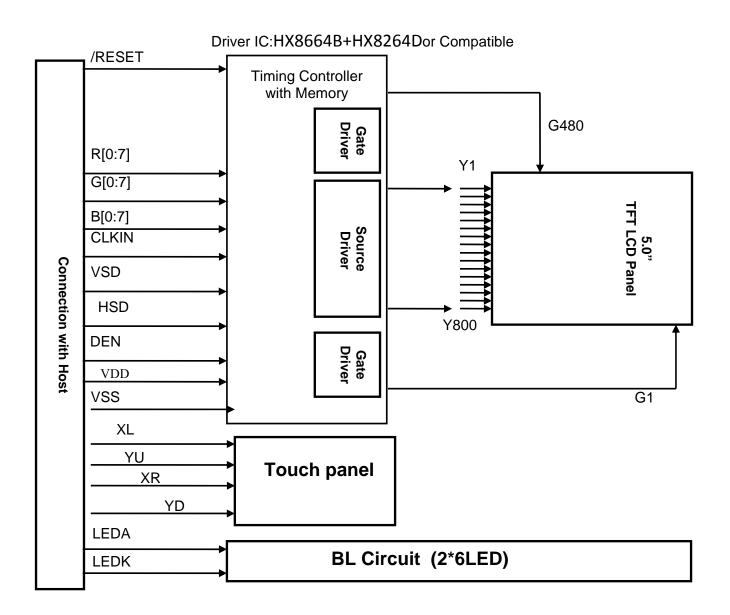
## 7. Interface Pin Function

Pin No	Symbol	Function
1	VLED-	BACK LIGHT POWER GROUND
2	VLED+	BACK LIGHT POWER SUPPLY
3	GND	POWER GROUND
4	VDD	POWER SUPPLY
5-12	R0-R7	RED DATA
13-20	G0-G7	GREEN DATA
21-28	B0-B7	BLUE DATA
29	GND	POWER GROUND
30	CLKIN	In external interface mode, served as a dot clock signal.
31	STBYB	standby mode control pin
32	HSD	In external interface mode, served as a horizontal synchronized signal input
33	VSD	In external interface mode, served as a vertical synchronize signal input
34	DEN	In external interface mode, polarity of ENABLE signal is synchronized with valid graphic data input.
35	NC	NC
36	GND	POWER GROUND
37	XR	
38	YD	TOUCH PANEL INTERFACE
39	XL	
40	YU	

NOTE:For digital RGB input data format, both SYNC mode and DE+SYNC mode are supported. If ENB signal is fixed low. SYNC mode is used. Otherwise, DEN+SYNC is used



## 8. BLOCK DIAGRAM





# 9. Standard Specification for Reliability

9-1. Standard Specifications for Reliability of LCD Module

No	Item	Description
01	High temperature operation	The sample should be allowed to stand at 70°C for 120 hours under driving condition and then returning it to normal temperature condition, and allowing it stand for 2 hours.
02	Low temperature operation	The sample should be allowed to stand at -20°C for 120 hours under driving condition and then returning it to normal temperature condition, and allowing it stand for 2 hours.
03	High temperature storage	The sample should be allowed to stand at 80°C for 240 hours under no-load condition, and then returning it to normal temperature condition, and allowing it stand for 2 hours.
04	Low temperature storage	The sample should be allowed to stand at -30°C for 240 hours under no-load condition, then returning it to normal temperature condition, and allowing it stand for 2 hours.
05	Moisture storage	The sample should be allowed to stand at 60°C,90%RH MAX for 240 hours under no-load condition, then taking it out and drying it at normal temperature for 2 hours.
06	Thermal shock storage	The sample should be allowed to stand the following 10 cycles: -30°C for 30 minutes → normal temperature for 5 minutes → +80°C for 30 minutes → normal temperature for 5 minutes, as one cycle.
07	Packing vibration	Frequency range : $10\text{Hz} \sim 55\text{Hz}$ Amplitude of vibration : $1.5\text{mm}$ Sweep time: $12\text{ min}$ X,Y,Z 2 hours for each direction.
08	Packing drop test	According to ASTM-D-5327.
09	Electrical Static	Air: $\pm 4$ KV 150pF/330 $\Omega$ 5 times
	Discharge	Contact: $\pm 2KV \ 150pF/330\Omega \ 5$ time

<sup>\*</sup>Sample size for each test item is 3~5pcs



## 9 - 2. Testing Conditions and Inspection Criteria

For the final test the testing sample must be stored at room temperature for 24 hours, after the tests listed in Table 12.2, Standard specifications for Reliability have been executed in order to ensure stability.

No	Item	Test Model	In section Criteria
01	Current Consumption	Refer To Specification	The current consumption should conform to the product specification.
02	Contrast	Refer To Specification	After the tests have been executed, the contrast must be larger than half of its initial value prior to the tests.
03	Appearance	Visual inspection	Defect free.

#### 9-3. MTBF

MTBF	Functions, performance, appearance, etc. shall be free from remarkable deterioration within 50,000 hours under ordinary operating and storage conditions room temperature (25 $\pm$ 5 $^{\circ}$ C), normal humidity (50 $\pm$ 10% RH), and in area not exposed to direct sun light.
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## 10. Specification of Quality Assurance:

#### 10-1. Purpose

This standard for Quality Assurance should affirm the quality of LCD module products to supply to purchaser by TeCenStar

#### 10-2. Standard for Quality Test

a. Inspection:

Before delivering, the supplier should take the following tests, and affirm the quality of product.

b. Electro-Optical Characteristics:

According to the individual specification to test the product.

c. Test of Appearance Characteristics:

According to the individual specification to test the product.

d. Test of Reliability Characteristics:

According to the definition of reliability on the specification for testing products.

e. Delivery Test:

Before delivering, the supplier should take the delivery test.

- (i) Test method: According to MIL-STD105E.General Inspection Level II take a single time.
- (ii) The defects classify of AQL as following:

Major defect: AQL = 0.65 Minor defect: AQL = 2.5 Total defects: AQL = 2.5

- 10-3. Non- conforming Analysis & Deal With Manners
- a. Non-conforming Analysis:
- (i) Purchaser should supply the detail data of non- conforming sample and the non- conforming.
- (ii) After accepting the detail data from purchaser, the analysis of non- conforming should be finished in two weeks.
  - (iii) If supplier can not finish analysis on time, must announce purchaser before 3 days.
  - b. Disposition of non- conforming:
  - (i) If find any product defect of supplier during assembly time, supplier must change the good product for every defect after recognition.

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(ii) Both supplier and customer should analyze the reason and discuss the disposition of non-conforming when the reason of nonconforming is not sure.

#### 10-4. Agreement items

Both sides should discuss together when the following problems happen.

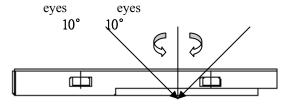
- a. There is any problem of standard of quality assurance, and both sides should think that must be modified.
- b. There is any argument item which does not record in the standard of quality assurance.
- c. Any other special problem.

Ver.02

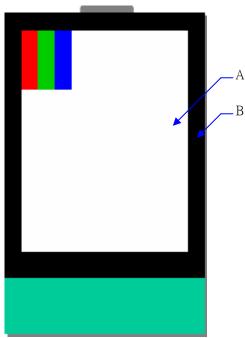


### 10-5. Standard of The Product Appearance Test

- a. Manner of appearance test:
- (i) The test must be under 20W × 2 or 40W fluorescent light, and the distance of view must be at 30±5cm.
- (ii) When test the model of transmissive product must add the reflective plate.
- (iii)The test direction is base on around 10° of vertical line.
- (iiii)Temperature: 25±5°C Humidity: 60±10%RH



#### (iv) Definition of area:



- A. Area: Viewing area.
- B. Area: Out of viewing area. (Outside viewing area)
- b. Basic principle:
- (i) It will accord to the AQL when the standard can not be described.
- (ii) The sample of the lowest acceptable quality level must be discussed by both supplier and customer when any dispute happened.

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- (iii) Must add new item on time when it is necessary.
- c. Standard of inspection: (Unit: mm)

Ver.02





10-6. Inspection specification

	Criterion				AQL
Electrical Testing	<ul> <li>1.1 Missing vertical, horizontal segment, segment contrast defect.</li> <li>1.2 Missing character, dot or icon.</li> <li>1.3 Display malfunction.</li> <li>1.4 No function or no display.</li> <li>1.5 Current consumption exceeds product specifications.</li> <li>1.6 LCD viewing angle defect.</li> <li>1.7 Mixed product types.</li> <li>1.8 Flicker</li> </ul>			0.65	
Black or White spots or Bright spots or Color spots on LCD (Display only)	<ul> <li>2.1 White and black or color spots on display ≤ 0.25mm, no more than Five spots.</li> <li>2.2 Densely spaced: No more than three spots within 3mm.</li> </ul>			2.5	
LCD and Touch Panel black spots, white spots, contamination (non – display)	$\Phi = (X+Y)^{\frac{1}{2}}$ $\longrightarrow X$ $\uparrow$ $\uparrow$ $\uparrow$ $\uparrow$	* Densely		Acceptable Q'ty Accept no dense  2 2 1 0 an two spots within 3mm.	2.5
	3.2 Line type: (As following)  W L	Length(m m)  L≤3.0 L≤2.5	$\begin{tabular}{c c} Width(mm) \\ \hline W \le 0.02 \\ \hline 0.02 < W \le 0.05 \\ \hline 0.03 < W \le 0.08 \\ \hline 0.08 < W \\ \hline \end{tabular}$	Acceptable Q'ty  Accept no dense  2  Rejection	2.5
	Black or White spots or Bright spots or Color spots on LCD (Display only)  LCD and Touch Panel black spots, white spots, contamination	1.2 Missing character, dot 1.3 Display malfunction. 1.4 No function or no disp 1.5 Current consumption of 1.6 LCD viewing angle de 1.7 Mixed product types. 1.8 Flicker   Black or White spots or Bright spots or Color spots on LCD (Display only)  3.1 Round type: As following Φ = (X+Y)/2  LCD and Touch Panel black spots, white spots, contamination  1.2 Missing character, dot 1.3 Display malfunction. 1.4 No function or no disp 1.5 Current consumption of 1.6 LCD viewing angle de 1.7 Mixed product types. 2.2 Densely spaced: No more spots or Color spots or Color spots or Color spots or Color spots or LCD (Display only)  3.1 Round type: As following the spots, white spots, contamination	1.2 Missing character, dot or icon. 1.3 Display malfunction. 1.4 No function or no display. 1.5 Current consumption exceeds produ 1.6 LCD viewing angle defect. 1.7 Mixed product types. 1.8 Flicker   2.1 White and black or color spots on dis 2.2 Densely spaced: No more than three  2.2 Densely spaced: No more than three  3.1 Round type: As following drawing Φ = (X+Y)/2   X  X  Y  LCD and Touch Panel black spots, white spots, contamination (non − display)  3.2 Line type: (As following drawing)  Length(m m)   L≤3.0  L≤2.5	1.2 Missing character, dot or icon. 1.3 Display malfunction. 1.4 No function or no display. 1.5 Current consumption exceeds product specifications. 1.6 LCD viewing angle defect. 1.7 Mixed product types. 1.8 Flicker  2.1 White and black or color spots on display ≤ 0.25mm, no 2.2 Densely spaced: No more than three spots within 3mm. 2.2 Densely spaced: No more than three spots within 3mm.  3.1 Round type: As following drawing Φ = (X+Y)/2   X  Size(mm) Φ≤0.10 0.10<Φ≤0.20 0.20<Φ≤0.25 0.25<Φ≤0.30 0.30<Φ  * Densely spaced: No more than three spots within 3mm.  * Densely spaced: No more than three spots within 3mm.  LCD and Touch Panel black spots, white spots, contamination (non − display)  3.2 Line type: (As following drawing)  Length(m Width(mm) m)  W≤0.02 L≤3.0 0.02 <w≤0.05 0.03<w≤0.08="" 0.08<w<="" l≤2.5="" td=""><td>1.2 Missing character, dot or icon. 1.3 Display malfunction. 1.4 No function or no display. 1.5 Current consumption exceeds product specifications. 1.6 LCD viewing angle defect. 1.7 Mixed product types. 1.8 Flicker  2.1 White and black or color spots on display ≤ 0.25mm, no more than Five spots. 2.2 Densely spaced: No more than three spots within 3mm.  2.2 Densely spaced: No more than three spots within 3mm.  3.1 Round type: As following drawing Φ = (X+Y) / 2     Size(mm)   Acceptable Q'ty   Φ ≤ 0.10   Accept no dense   0.10 &lt; Φ ≤ 0.20   2   0.20 &lt; Φ ≤ 0.25   2   0.25 &lt; Φ ≤ 0.30   1   0.30 &lt; Φ   0   0.30 &lt; Φ   0    3.2 Line type: (As following drawing)    Length(m   Width(mm)   Acceptable Q'ty   m)   Length(m   Width(mm)   Acceptable Q'ty   m)   Length(m   Width(mm)   Acceptable Q'ty   m)   Length(m   Width(mm)   Acceptable Q'ty   Length(m   Width(mm)   Acceptable Q'ty   m)   Length(m   Width(mm)   Acceptable Q'ty   Length(m   Width(mm)   Acceptable Q'ty   Length(m   Width(mm)   Acceptable Q'ty   m)   Length(m   Width(mm)   Acceptable Q'ty   Le</td></w≤0.05>	1.2 Missing character, dot or icon. 1.3 Display malfunction. 1.4 No function or no display. 1.5 Current consumption exceeds product specifications. 1.6 LCD viewing angle defect. 1.7 Mixed product types. 1.8 Flicker  2.1 White and black or color spots on display ≤ 0.25mm, no more than Five spots. 2.2 Densely spaced: No more than three spots within 3mm.  2.2 Densely spaced: No more than three spots within 3mm.  3.1 Round type: As following drawing Φ = (X+Y) / 2     Size(mm)   Acceptable Q'ty   Φ ≤ 0.10   Accept no dense   0.10 < Φ ≤ 0.20   2   0.20 < Φ ≤ 0.25   2   0.25 < Φ ≤ 0.30   1   0.30 < Φ   0   0.30 < Φ   0    3.2 Line type: (As following drawing)    Length(m   Width(mm)   Acceptable Q'ty   m)   Length(m   Width(mm)   Acceptable Q'ty   m)   Length(m   Width(mm)   Acceptable Q'ty   m)   Length(m   Width(mm)   Acceptable Q'ty   Length(m   Width(mm)   Acceptable Q'ty   m)   Length(m   Width(mm)   Acceptable Q'ty   Length(m   Width(mm)   Acceptable Q'ty   Length(m   Width(mm)   Acceptable Q'ty   m)   Length(m   Width(mm)   Acceptable Q'ty   Le



NO	Item	Criterion			
04	Polarizer bubbles	If bubbles are visible, judge using black spot specifications, not easy to find, must check in specify direction	Size Φ(mm) $\Phi \le 0.20$ $0.20 < \Phi \le 0.50$ $0.50 < \Phi \le 1.00$ $1.00 < \Phi$ $Total Q'ty$	Acceptable Q'ty Accept no dense 3 2 0 3	2.5
05	Scratches	Follow NO.3 -2 Line Type.			
06	Chipped glass	x: Chip length y: Chip width z: Ch k: Seal width t: Glass thickness a: L L: Electrode pad length 6.1 General glass chip: 6.1.1 Chip on panel surface and crack be  z: Chip thickness y: Chip width Z≤1/2t Not over vie 1/2t< z≤2t Not excee  Unit: mm If there are 2 or more chips, x is the to 6.1.2 Corner crack:  z: Chip thickness y: Chip width Z≤1/2t Not over vie 1/2t< z≤2t Not excee  Unit: mm If there are 2 or more chips, x is the to 1/2t< z≤2t Not excee  Unit: mm If there are 2 or more chips, x is the to	tween panels:    X: Chip lem   X   S     Wing area   X   S     otal length of each chip       x: Chip lem   X   S     otal length of each chip       x: Chip lem   X   S     otal length of each chip       x: Chip lem   X   S     otal length of each chip     otal length of each chip   X   S     otal length	1/8a 1/8a	2.5



NO	Item	Criterion				
	Symbols: x: Chip length y: Chip width z: Chip thickness k: Seal width t: Glass thickness a: LCD side length L: Electrode pad length 7.2 Protrusion over terminal: 7.2.1 Chip on electrode pad:					
		y: Chip width x: Chip length z: Chip thickness				
		$y \leq 0.5 \text{mm} \qquad x \leq 1/8 \text{a} \qquad 0 < z \leq t$				
		7.2.2 Non-conductive portion:				
07	Glass crack	y z z z z z z z z z z z z z z z z z z z	2.5			
		y: Chip width x: Chip length z: Chip thickness				
		$y \le L$ $x \le 1/8a$ $0 < z \le t$				
		be inspe ⊙ If the produmaged	<ul> <li>If there chipped area touches the ITO terminal, over 2/3 of the ITO must remain and be inspected according to electrode terminal specifications.</li> <li>If the product will be heat sealed by the customer, the alignment mark must mot be damaged.</li> <li>Substrate protuberance and internal crack</li> </ul> y: width <ul> <li>x: length</li> </ul>	!		
		$y \le 1/3L$ $X \le a$				



NO	Item	Criterion	AQL
08	Cracked glass	The LCD with extensive crack is not acceptable.	2.5
09	Backlight elements	<ul> <li>9.1 Illumination source flickers when lit.</li> <li>9.2 Spots or scratches that appear when lit must be judged. Using LCD spot, lines and contamination standards.</li> <li>9.3 Backlight doesn't light or color is wrong.</li> </ul>	2.5 2.5 0.65
10	Bezel	Bezel must comply with product specifications.	2.5
11	РСВ、СОВ	<ul> <li>11.1 COB seal may not have pinholes larger than 0.2mm or contamination.</li> <li>11.2 COB seal surface may not have pinholes through to the IC.</li> <li>11.3 The height of the COB should not exceed the height indicated in the assembly diagram.</li> <li>11.4 There may not be more than 2mm of sealant outside the seal area on PCB. And there should be no more than three places.</li> <li>11.5 Parts on PCB must be the same as on the production characteristic chart, There should be no wrong parts, missing parts or excess parts.</li> <li>11.6 The jumper on the PCB should conform to the product characteristic chart.</li> </ul>	2.5 2.5 2.5 2.5 0.65
12	FPC	12.1 FPC terminal damage $\leq$ 1/2 FPC terminal width and can not affect the function , we judge accept. 12.2 FPC alignment hole damage $\leq$ 1/2 alignment area and can not affect the function , we judge accept.	2.5
13	Soldering	<ul><li>13.1 No cold solder joints, missing solder connections, oxidation or icicle.</li><li>13.2 No short circuits in components on PCB or FPC.</li></ul>	2.5 0.65



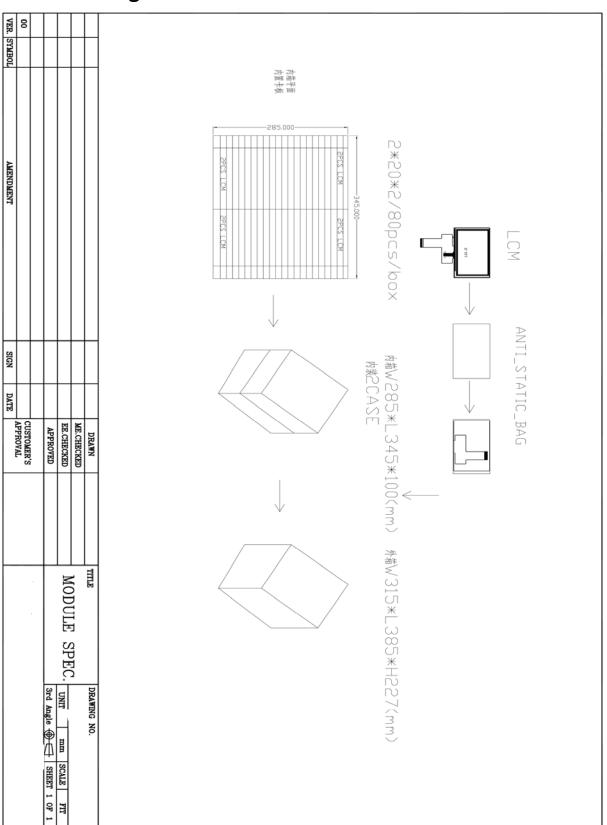
NO	Item	Criterion A				
110	Touch Panel Chipped glass	Symbols: x: Chip length y: Chip width z: Chip thickness k: Seal width t: Touch Panel Total thickness a: LCD side length L: Electrode pad length 14.1 General glass chip: 14.1.1 Chip on panel surface and crack between panels:				
		z: Chip thickness Z≦t	y: Chip width  ≤ 1/2 k and not over viewing area	x: Chip length x≤1/8a		
14		<ul> <li>⊙ Unit: mm</li> <li>⊙ If there are 2 or more 14.1.2 Corner crack:</li> </ul>	chips, x is the total length of	each chip		2.5
		z: Chip thickness	y: Chip width	x: Chip length		
		z≦t	≤1/2 k and not over viewing area	x≤1/8a		
			<ul><li>⊙ Unit: mm</li><li>⊙ If there are 2 or more</li></ul>	chips, x is the total length of	each chip	



NO	Item	Criterion	AQL	
15	Touch Panel(Fish eye, dent and bubble on film)		2.5	
16	Touch Panel Newton ring	Newton ring dimension $\leq 1/2$ touch panel area and not affect font and line distortion( $\leq 2.5\%$ ), it is acceptable.		
17	Touch Panel Linearity	Less than 2.5% is acceptable.		
18	LCD Ripple	Touch the touch panel, can not see the LCD ripple. Pen: R 1.0mm silicon rubber. Operation Force: 80g		
19	General appearance	<ul> <li>19.1 Pin type must match type in specification sheet.</li> <li>19.2 LCD pin loose or missing pins.</li> <li>19.3 Product packaging must the same as specified on packaging specification sheet.</li> <li>19.4 Product dimension and structure must conform to product specification sheet.</li> </ul>		



# 11. Packing method





## 12.TeCenStar LCM Named

```
COG - (A) (B) (C) (D) (E) (F) - 01 (Example: COG-C147MVHC-01 or COG-T240MZQI-01)
TLM - (A)(B)(C)(D)(E)(F) - 01 (for Module with COG Process)
(A) Type:
                         Τ
      TFT
      CSTN
                         \mathbf{C}
      OLED
                                                   O
      PLED
                                                   P
(B) Size:
       1.18^{\prime\,\prime}
                                          118
       2.83
                                                   283
       10.4^{\prime\,\prime}
                                                   A40
       15′
                                                   F00
(C) Mode:
      For CSTN/TFT
       Transflective:
                                          F
       Transmissive:
                                          M
      For OLED/PLED
                                          S
       Mono:
       Area Color:
                                          Α
                                          C
       Color:
       Grayscale:
                                          G
(D) Panel Supplier:
       ALPS
                                          Α
       BOE
                                          В
       CMO
                                          C
       Toppoly
                                          F
       Hannstar
                                          Н
       Hitachi
                                          I
       LG Philips
                                          L
       PVI
                                          P
       RIT
                                          R
       Tianma
                                          T
       Varitronix
                                          V
       Unvision
                                          U
       Kyocera
                                          K
       Ness
                                                   N
                                                   \mathbf{S}
       Sharp
                                                   Z
       CPT
(E) Resolution:
                                          48
                         64
                                  X
                                                                    L
                         80
                                  X
                                          48
                                                                    Α
                                  X
                         96
                                          36
                                                                    В
                         96
                                  \mathbf{X}
                                          64
                                                                    \mathbf{C}
                         96
                                  X
                                          96
                                                                    D
                         101
                                  X
                                          80
                                                                    I
                         128
                                  X
                                          33
                                                                    M
                         128
                                  X
                                          64
                                                                    K
      SQCIF
                         128
                                  X
                                          96
                                                                    Е
                         176
                                  X
                                          220
                                                                    F
      QCIF
                         128
                                                                    G
                                  X
                                          128
                                  X
                         160
                                          120
                                                                    J
      QQVGA
                                  X
                                          128
                                                                    Η
                         160
```



#### COG-T500MTWH-01P

0100 2002400	4				
QVGA	320	X	240	Q	
/	480	X	234	R	
/	480	X	220	N	
/	480	X	468	O	
VGA	640	X	480	V	
WVGA	800	X	480	$\mathbf{W}$	
WQVGA	400	X	240	W	
/	800	X	600	K	
	Others	3		Z	
(F) IC Supplier:					
ILI			I		
Sitronix			S		
LG			L		
NT			N	I	
HIMAX			Н		